

- Member of the Texas Instruments Widebus™ Family
- Low-Power Advanced CMOS Technology
- Operates From 3-V to 3.6-V  $V_{CC}$
- Load Clock and Unload Clock Can Be Asynchronous or Coincident
- Full, Empty, and Half-Full Flags
- Programmable Almost-Full/Almost-Empty Flag
- Fast Access Times of 18 ns With a 50-pF Load and All Data Outputs Switching Simultaneously
- Data Rates up to 40 MHz
- 3-State Outputs
- Pin-to-Pin Compatible With SN74ACT7804, SN74ACT7806, and SN74ACT7814
- Packaged in Shrink Small-Outline 300-mil Package Using 25-mil Center-to-Center Spacing

## description

A FIFO memory is a storage device that allows data to be written into and read from its array at independent data rates. The SN74ALVC7814 is an 18-bit FIFO with high speed and fast access times. Data is processed at rates up to 40 MHz with access times of 18 ns in a bit-parallel format. These memories are designed for 3-V to 3.6-V  $V_{CC}$  operation.

Data is written into memory on a low-to-high transition of the load clock (LDCK) and is read out on a low-to-high transition of the unload clock (UNCK). The memory is full when the number of words clocked in exceeds the number of words clocked out by 64. When the memory is full, LDCK has no effect on the data residing in memory. When the memory is empty, UNCK has no effect.

Status of the FIFO memory is monitored by the full ( $\overline{FULL}$ ), empty ( $\overline{EMPTY}$ ), half-full (HF), and almost-full/almost-empty (AF/AE) flags. The  $\overline{FULL}$  output is low when the memory is full and high when the memory is not full. The  $\overline{EMPTY}$  output is low when the memory is empty and high when it is not empty. The HF output is high whenever the FIFO contains 32 or more words and low when it contains 31 or fewer words. The AF/AE status flag is a programmable flag. The first one or two low-to-high transitions of LDCK after reset are used to program the almost-empty offset value (X) and the almost-full offset value (Y) if program enable ( $\overline{PEN}$ ) is low. The AF/AE flag is high when the FIFO contains X or fewer words or  $(64 - Y)$  or more words. The AF/AE flag is low when the FIFO contains between  $(X + 1)$  and  $(63 - Y)$  words.

DL PACKAGE  
(TOP VIEW)

|                  |    |    |          |
|------------------|----|----|----------|
| RESET            | 1  | 56 | OE       |
| D17              | 2  | 55 | Q17      |
| D16              | 3  | 54 | Q16      |
| D15              | 4  | 53 | Q15      |
| D14              | 5  | 52 | GND      |
| D13              | 6  | 51 | Q14      |
| D12              | 7  | 50 | $V_{CC}$ |
| D11              | 8  | 49 | Q13      |
| D10              | 9  | 48 | Q12      |
| $V_{CC}$         | 10 | 47 | Q11      |
| D9               | 11 | 46 | Q10      |
| D8               | 12 | 45 | Q9       |
| GND              | 13 | 44 | GND      |
| D7               | 14 | 43 | Q8       |
| D6               | 15 | 42 | Q7       |
| D5               | 16 | 41 | Q6       |
| D4               | 17 | 40 | Q5       |
| D3               | 18 | 39 | $V_{CC}$ |
| D2               | 19 | 38 | Q4       |
| D1               | 20 | 37 | Q3       |
| D0               | 21 | 36 | Q2       |
| HF               | 22 | 35 | GND      |
| $\overline{PEN}$ | 23 | 34 | Q1       |
| AF/AE            | 24 | 33 | Q0       |
| LDCK             | 25 | 32 | UNCK     |
| NC               | 26 | 31 | NC       |
| NC               | 27 | 30 | NC       |
| FULL             | 28 | 29 | EMPTY    |

NC – No internal connection



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**TEXAS  
INSTRUMENTS**

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SN74ALVC7814

64 × 18

LOW-POWER FIRST-IN, FIRST-OUT MEMORY

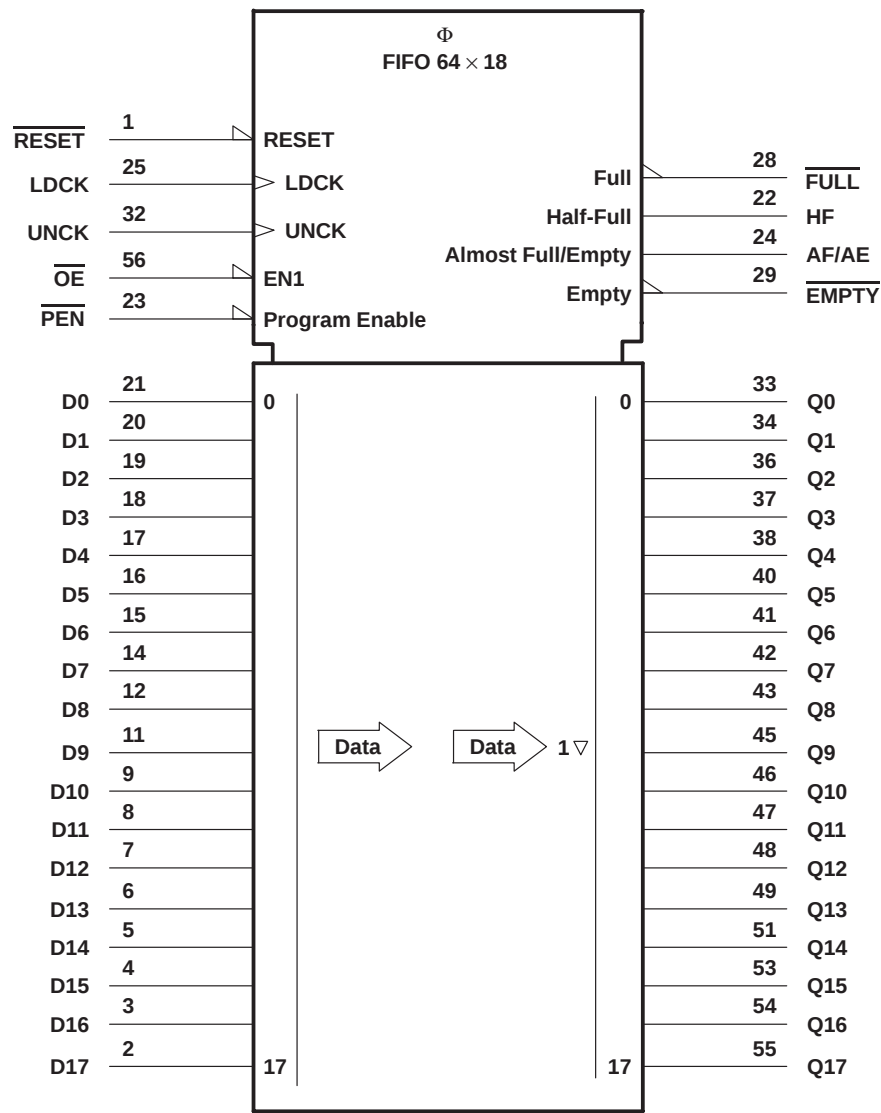
SCAS592A – OCTOBER 1997 – REVISED APRIL 1998

description (continued)

A low level on the reset ( $\overline{\text{RESET}}$ ) resets the internal stack pointers and sets  $\overline{\text{FULL}}$  high, AF/AE high, HF low, and  $\overline{\text{EMPTY}}$  low. The Q outputs are not reset to any specific logic level. The FIFO must be reset on power up. The first word loaded into empty memory causes  $\overline{\text{EMPTY}}$  to go high and the data to appear on the Q outputs. The data outputs are in the high-impedance state when the output-enable ( $\overline{\text{OE}}$ ) is high.

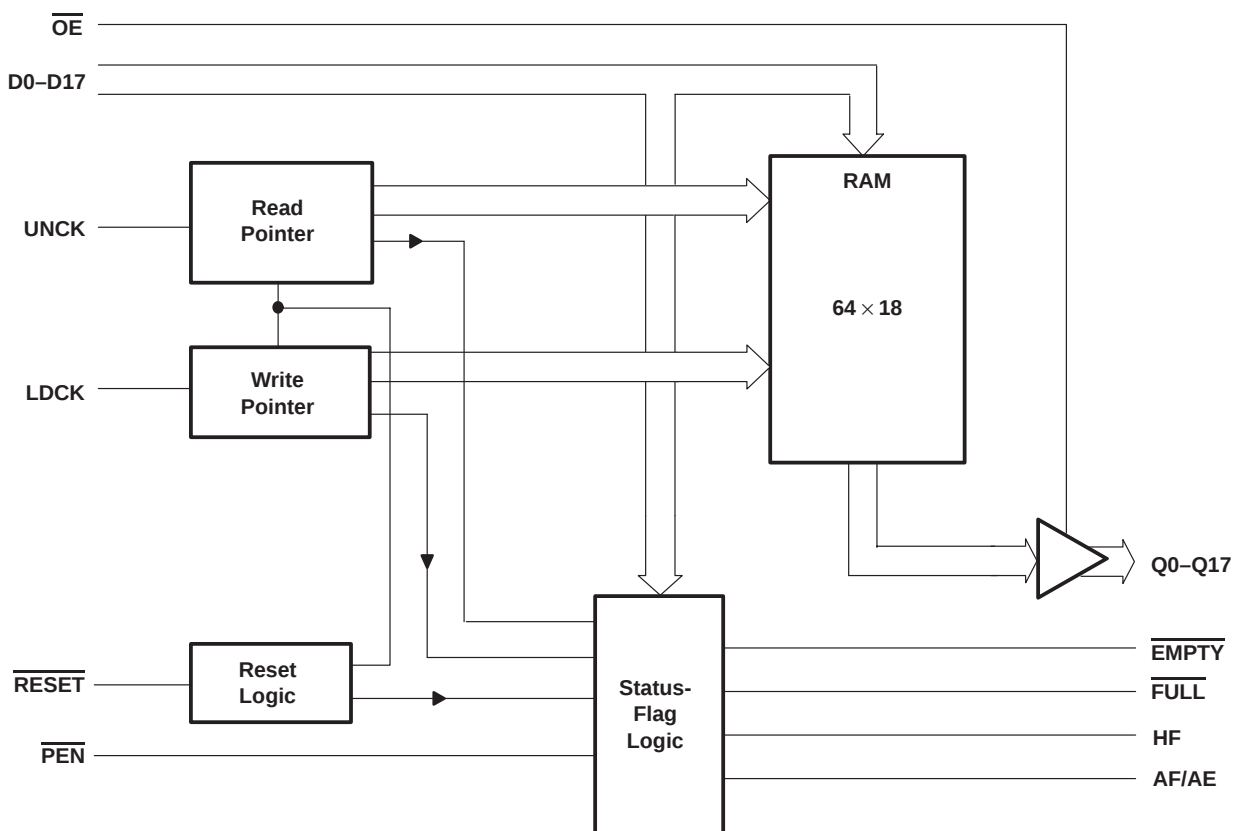
The SN74ALVC7814 is characterized for operation from 0°C to 70°C.

logic symbol†



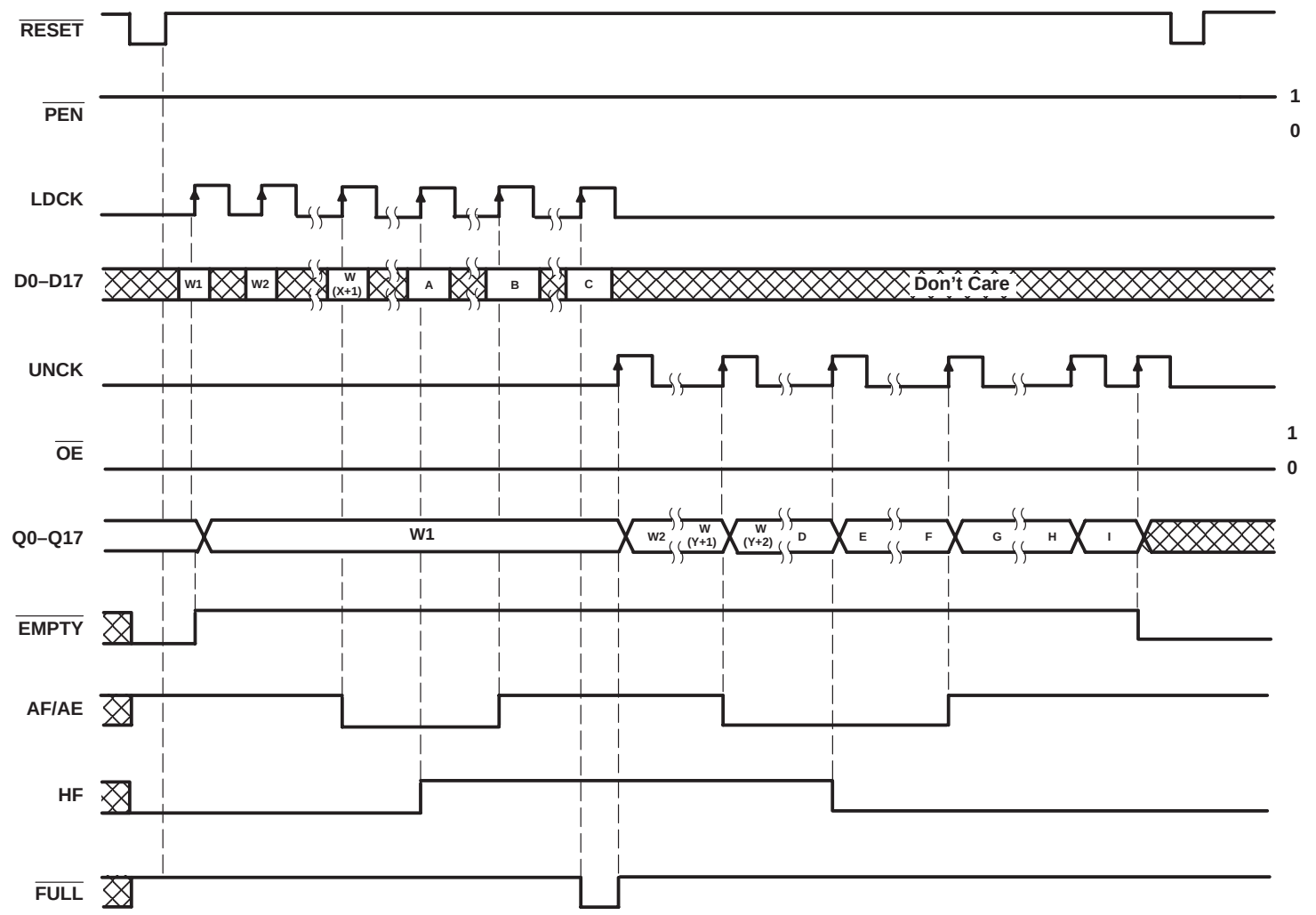
† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

## functional block diagram



## Terminal Functions

| TERMINAL<br>NAME        | NO.                                         | I/O | DESCRIPTION                                                                                                                                                                                                                                                                                              |
|-------------------------|---------------------------------------------|-----|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| AF/AE                   | 24                                          | O   | Almost full/almost empty flag. Depth-offset values can be programmed for this flag or the default value of 64 can be used for both the almost empty offset (X) and the almost full offset (Y). AF/AE is high when memory contains X or fewer words or (64 – Y) or more words. AF/AE is high after reset. |
| D0–D17                  | 2–9, 11–12,<br>14–21                        | I   | 18-bit data input port                                                                                                                                                                                                                                                                                   |
| EMPTY                   | 29                                          | O   | Empty flag. $\overline{\text{EMPTY}}$ is low when the FIFO is empty. A FIFO reset also causes $\overline{\text{EMPTY}}$ to go low.                                                                                                                                                                       |
| FULL                    | 28                                          | O   | Full flag. $\overline{\text{FULL}}$ is low when the FIFO is full. A FIFO reset causes $\overline{\text{FULL}}$ to go high.                                                                                                                                                                               |
| HF                      | 22                                          | O   | Half-full flag. HF is high when the FIFO memory contains 32 or more words. HF is low after reset.                                                                                                                                                                                                        |
| LDCK                    | 25                                          | I   | Load clock. Data is written to the FIFO on the rising edge of LDCK when $\overline{\text{FULL}}$ is high.                                                                                                                                                                                                |
| $\overline{\text{OE}}$  | 56                                          | I   | Output enable. When $\overline{\text{OE}}$ is high, the data outputs are in the high-impedance state.                                                                                                                                                                                                    |
| $\overline{\text{PEN}}$ | 23                                          | I   | Program enable. After reset and before the first word is written to the FIFO, the binary value on D0–D7 is latched as an AF/AE offset value when $\overline{\text{PEN}}$ is low and WRTCLK is high.                                                                                                      |
| Q0–Q17                  | 33–34, 36–38,<br>40–43, 45–49,<br>51, 53–55 | O   | 18-bit data output port                                                                                                                                                                                                                                                                                  |
| RESET                   | 1                                           | I   | Reset. A low level on $\overline{\text{RESET}}$ resets the FIFO and drives AF/AE and $\overline{\text{FULL}}$ high and HF and $\overline{\text{EMPTY}}$ low.                                                                                                                                             |
| UNCK                    | 32                                          | I   | Unload clock. Data is read from the FIFO on the rising edge of UNCK when $\overline{\text{EMPTY}}$ is high.                                                                                                                                                                                              |



Define the AF/AE Flag Using the Default Value of X and Y

Figure 1. Write, Read, and Flag Timing Reference

DATA-WORD NUMBERS FOR FLAG TRANSITIONS

| DEVICE       | TRANSITION WORD |           |     |     |     |           |           |     |     |
|--------------|-----------------|-----------|-----|-----|-----|-----------|-----------|-----|-----|
|              | A               | B         | C   | D   | E   | F         | G         | H   | I   |
| SN74ALVC7814 | W32             | W(64 – Y) | W64 | W33 | W34 | W(64 – X) | W(65 – X) | W64 | W64 |

Figure 1. Write, Read, and Flag Timing Reference (Continued)

## offset values for AF/AE

The AF/AE flag has two programmable limits: the almost-empty offset value (X) and the almost-full offset value (Y). They can be programmed after the FIFO is reset and before the first word is written to memory. The AF/AE flag is high when the FIFO contains X or fewer words or (512 – Y) or more words.

To program the offset values,  $\overline{\text{PEN}}$  can be brought low after reset. On the following low-to-high transition of LDCK, the binary value on D0–D7 is stored as the almost-empty offset value (X) and the almost-full offset value (Y). Holding  $\overline{\text{PEN}}$  low for another low-to-high transition of LDCK reprograms Y to the binary value on D0–D7 at the time of the second LDCK low-to-high transition. Writes to the FIFO memory are disabled while the offsets are programmed. A maximum value of 32 can be programmed for either X or Y (see Figure 2). To use the default values of X = Y = 8,  $\overline{\text{PEN}}$  must be held high.

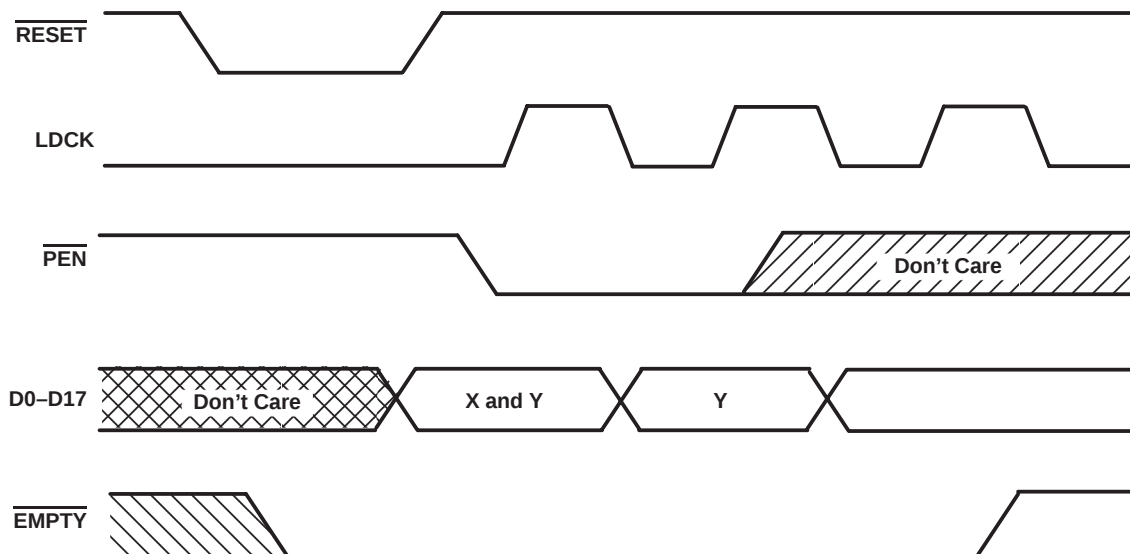


Figure 2. Programming X and Y Separately

**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>**

|                                                                |                            |
|----------------------------------------------------------------|----------------------------|
| Supply voltage range, $V_{CC}$                                 | –0.5 V to 4.6 V            |
| Input voltage range, $V_I$ (see Note 1)                        | –0.5 V to 4.6 V            |
| Output voltage range, $V_O$ (see Notes 1 and 2)                | –0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )                    | –50 mA                     |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) | ±50 mA                     |
| Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )     | ±50 mA                     |
| Continuous current through $V_{CC}$ or GND                     | ±100 mA                    |
| Voltage applied to a disabled 3-state output                   | –0.5 V to 3.6 V            |
| Package thermal impedance, $\theta_{JA}$ (see Note 3)          | 74°C/W                     |
| Storage temperature range, $T_{stg}$                           | –65°C to 150°C             |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings can be exceeded if the input and output clamp-current ratings are observed.  
 2. This value is limited to 4.6 V maximum.  
 3. The package thermal impedance is calculated in accordance with JESD 51.

**recommended operating conditions**

|          |                                             | 'ALVC7814-25   |          | 'ALVC7814-40 |          | UNIT |
|----------|---------------------------------------------|----------------|----------|--------------|----------|------|
|          |                                             | MIN            | MAX      | MIN          | MAX      |      |
| $V_{CC}$ | Supply voltage                              | 3              | 3.6      | 3            | 3.6      | V    |
| $V_{IH}$ | High-level input voltage                    | 2              |          | 2            |          | V    |
| $V_{IL}$ | Low-level input voltage                     |                | 0.8      |              | 0.8      | V    |
| $V_I$    | Input voltage                               | 0              | $V_{CC}$ | 0            | $V_{CC}$ | V    |
| $V_O$    | Output voltage                              | 0              | $V_{CC}$ | 0            | $V_{CC}$ | V    |
| $I_{OH}$ | High-level output current, Q outputs, flags | $V_{CC} = 3$ V |          | –8           |          | mA   |
| $I_{OL}$ | Low-level output current, Q outputs, flags  | $V_{CC} = 3$ V |          | 16           |          | mA   |
| $T_A$    | Operating free-air temperature              | 0              | 70       | 0            | 70       | °C   |

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

| PARAMETER |                  | TEST CONDITIONS                                                 |                         | MIN     | TYP‡ | MAX  | UNIT |
|-----------|------------------|-----------------------------------------------------------------|-------------------------|---------|------|------|------|
| VOH       | Flags, Q outputs | VCC = 3 V to 3.6 V,                                             | IOH = −100 μA           | VCC−0.2 |      |      | V    |
|           |                  | VCC = 3 V,                                                      | IOH = −8 mA             | 2.4     |      |      |      |
| VOL       | Flags, Q outputs | VCC = 3 V to 3.6 V,                                             | IOL = 100 μA            |         |      | 0.2  | V    |
|           | Flags            | VCC = 3 V,                                                      | IOL = 8 mA              |         |      | 0.4  |      |
|           | Q outputs        | VCC = 3 V,                                                      | IOL = 16 mA             |         |      | 0.55 |      |
| II        |                  | VCC = 3.6 V,                                                    | VI =VCC or GND          |         |      | ±5   | μA   |
| IOZ       |                  | VCC = 3.6 V,                                                    | VO =VCC or GND          |         |      | ±10  | μA   |
| ICC       |                  | VCC = 3.6 V,                                                    | VI = VCC or GND, IO = 0 |         |      | 40   | μA   |
| ΔICC§     |                  | VCC = 3.6 V, One input at VCC−0.6 V, Other inputs at VCC or GND |                         |         |      | 500  | μA   |
| Ci        |                  | VCC = 3.3 V,                                                    | VI = VCC or GND         |         |      | 3    | pF   |
| Co        |                  | VCC = 3.3 V,                                                    | VO = VCC or GND         |         |      | 6    | pF   |

<sup>‡</sup> All typical values are at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$ .

<sup>\S</sup> This is the supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or  $V_{CC}$ .

## timing requirements over recommended operating conditions (see Figures 1 through 3)

|                    |                 |                                                     | 'ALVC7814-25 |     | 'ALVC7814-40 |     | UNIT |
|--------------------|-----------------|-----------------------------------------------------|--------------|-----|--------------|-----|------|
|                    |                 |                                                     | MIN          | MAX | MIN          | MAX |      |
| f <sub>clock</sub> | Clock frequency |                                                     | 40           |     | 25           |     | MHz  |
| t <sub>w</sub>     | Pulse duration  | D0–D17 high or low                                  | 8            |     | 12           |     | ns   |
|                    |                 | LDCK high or low                                    | 8            |     | 12           |     |      |
|                    |                 | UNCK high or low                                    | 8            |     | 12           |     |      |
|                    |                 | $\overline{\text{PEN}}$ low                         | 8            |     | 12           |     |      |
|                    |                 | $\overline{\text{RESET}}$ low                       | 10           |     | 12           |     |      |
| t <sub>su</sub>    | Setup time      | D0–D17 before LDCK↑                                 | 5            |     | 5            |     | ns   |
|                    |                 | LDCK inactive before $\overline{\text{RESET}}$ high | 6            |     | 6            |     |      |
|                    |                 | $\overline{\text{PEN}}$ before LDCK↑                | 8            |     | 8            |     |      |
| t <sub>h</sub>     | Hold time       | D0–D17 after LDCK↑                                  | 0            |     | 0            |     | ns   |
|                    |                 | $\overline{\text{PEN}}$ high after LDCK low         | 0            |     | 0            |     |      |
|                    |                 | $\overline{\text{PEN}}$ low after LDCK↑             | 3            |     | 3            |     |      |
|                    |                 | LDCK inactive after $\overline{\text{RESET}}$ high  | 6            |     | 6            |     |      |

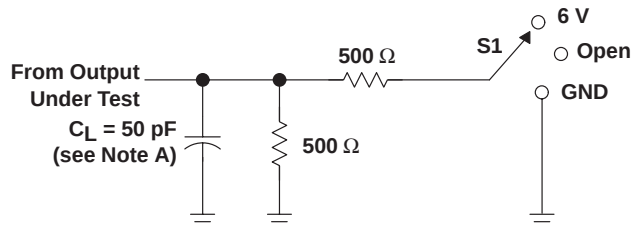
switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C<sub>L</sub> = 50 pF (unless otherwise noted) (see Figure 3)

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | 'ALVC7814-25 |     | 'ALVC7814-40 |     | UNIT |
|------------------|-----------------|----------------|--------------|-----|--------------|-----|------|
|                  |                 |                | MIN          | MAX | MIN          | MAX |      |
| f <sub>max</sub> | LDCK or UNCK    |                | 40           |     | 25           |     | MHz  |
| t <sub>pd</sub>  | LDCK↑           | Any Q          | 9            | 22  | 9            | 24  | ns   |
|                  | UNCK↑           |                | 6            | 18  | 6            | 20  |      |
| t <sub>PLH</sub> | LDCK↑           | EMPTY          | 6            | 17  | 6            | 19  | ns   |
| t <sub>PHL</sub> | UNCK↑           | EMPTY          | 6            | 17  | 6            | 19  | ns   |
|                  | RESET low       |                | 4            | 18  | 4            | 20  |      |
| t <sub>PLH</sub> | UNCK↑           | FULL           | 6            | 17  | 6            | 19  | ns   |
|                  | RESET low       |                | 4            | 20  | 4            | 22  |      |
| t <sub>PHL</sub> | LDCK↑           | FULL           | 6            | 17  | 6            | 19  | ns   |
| t <sub>pd</sub>  | LDCK↑           | AF/AE          | 7            | 20  | 7            | 22  | ns   |
|                  | UNCK↑           |                | 7            | 20  | 7            | 22  |      |
| t <sub>PLH</sub> | RESET low       | AF/AE          | 2            | 12  | 2            | 14  | ns   |
|                  | LDCK↑           | HF             | 5            | 20  | 5            | 22  |      |
| t <sub>PHL</sub> | UNCK↑           | HF             | 7            | 20  | 7            | 22  | ns   |
|                  | RESET low       |                | 3            | 14  | 3            | 16  |      |
| t <sub>en</sub>  | OE              | Any Q          | 2            | 10  | 2            | 11  | ns   |
| t <sub>dis</sub> | OE              | Any Q          | 2            | 11  | 2            | 12  | ns   |

operating characteristics, V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C

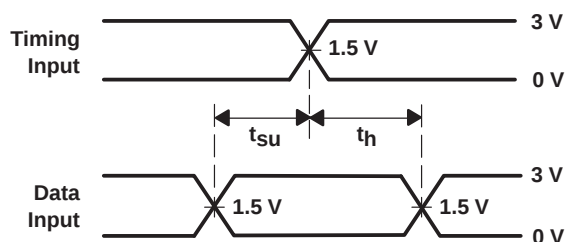
| PARAMETER       |                                                |                 | TEST CONDITIONS                   |  | TYP | UNIT |
|-----------------|------------------------------------------------|-----------------|-----------------------------------|--|-----|------|
| C <sub>pd</sub> | Power dissipation capacitance per FIFO channel | Outputs enabled | C <sub>L</sub> = 50 pF, f = 5 MHz |  | 53  | pF   |

## PARAMETER MEASUREMENT INFORMATION

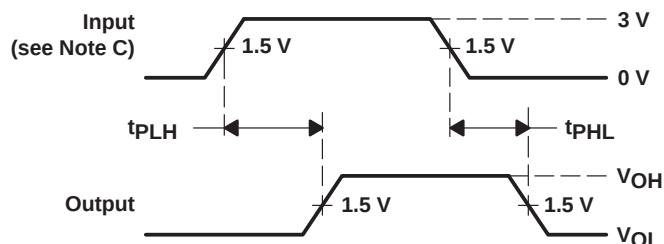


### LOAD CIRCUIT FOR OUTPUTS

| PARAMETER        |                                    | S1   |
|------------------|------------------------------------|------|
| t <sub>en</sub>  | t <sub>PZH</sub>                   | GND  |
|                  | t <sub>PZL</sub>                   | 6 V  |
| t <sub>dis</sub> | t <sub>PHZ</sub>                   | GND  |
|                  | t <sub>PLZ</sub>                   | 6 V  |
| t <sub>pd</sub>  | t <sub>PLH</sub> /t <sub>PHL</sub> | Open |

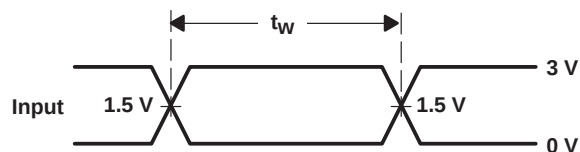


## VOLTAGE WAVEFORMS SETUP AND HOLD TIMES



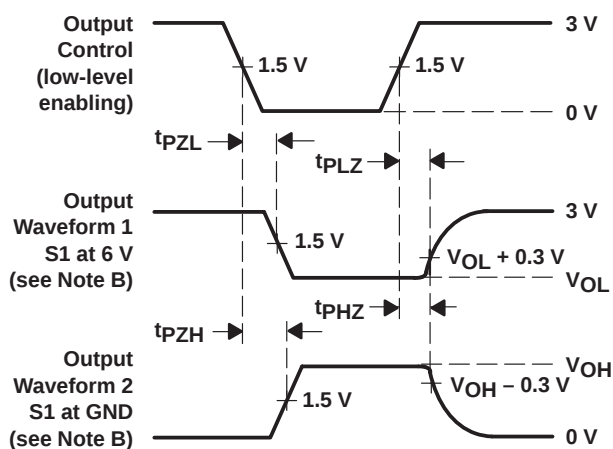
## VOLTAGE WAVEFORMS

### PROPAGATION DELAY TIMES



### VOLTAGE WAVEFORMS

### PULSE DURATION



## VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES

NOTES: A.  $C_1$  includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10$  MHz,  $Z_0 = 50 \Omega$ ,  $t_r \leq 2.5$  ns,  $t_f \leq 2.5$  ns.

**Figure 3. Standard CMOS Outputs (FULL, EMPTY, HF, AF/AE)**

## TYPICAL CHARACTERISTICS

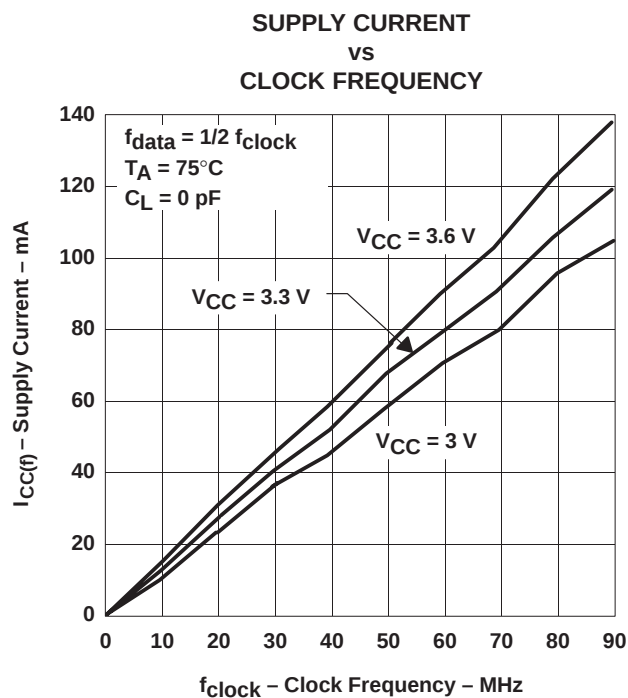


Figure 4

## APPLICATION INFORMATION

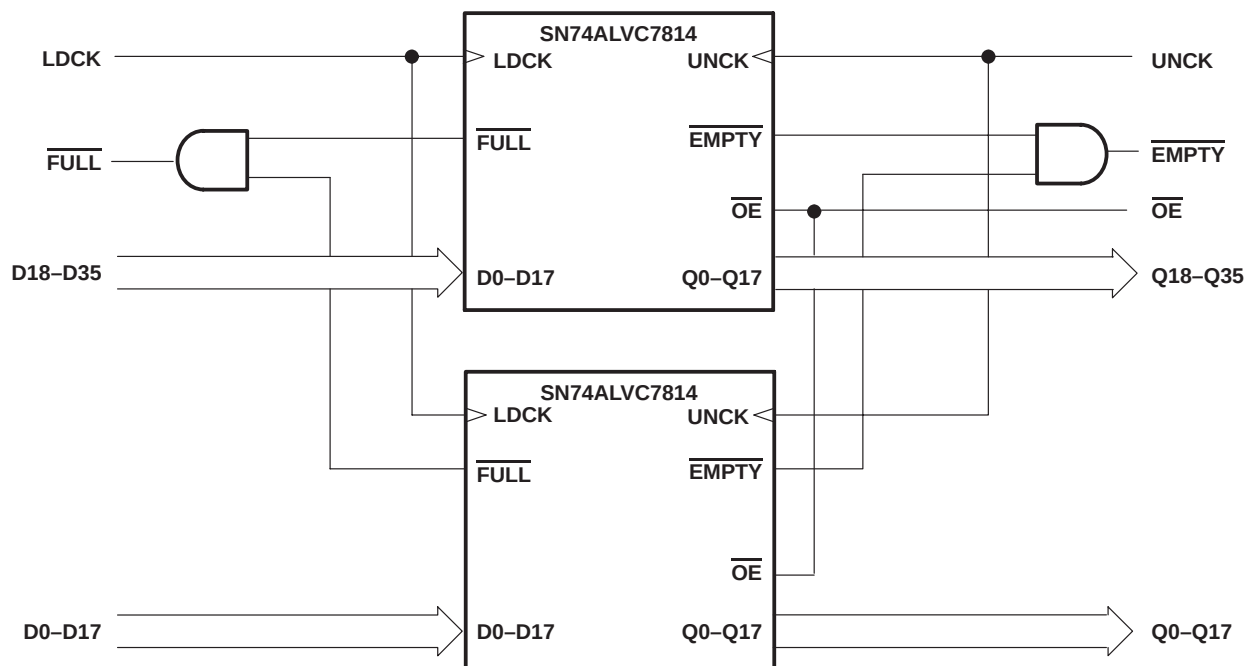


Figure 5. Word-Width Expansion: 64 × 36 Bits

## PACKAGING INFORMATION

| Orderable part number             | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">SN74ALVC7814-40DL</a> | Active        | Production           | SSOP (DL)   56 | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | ALVC7814-40         |
| SN74ALVC7814-40DL.A               | Active        | Production           | SSOP (DL)   56 | 20   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | ALVC7814-40         |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

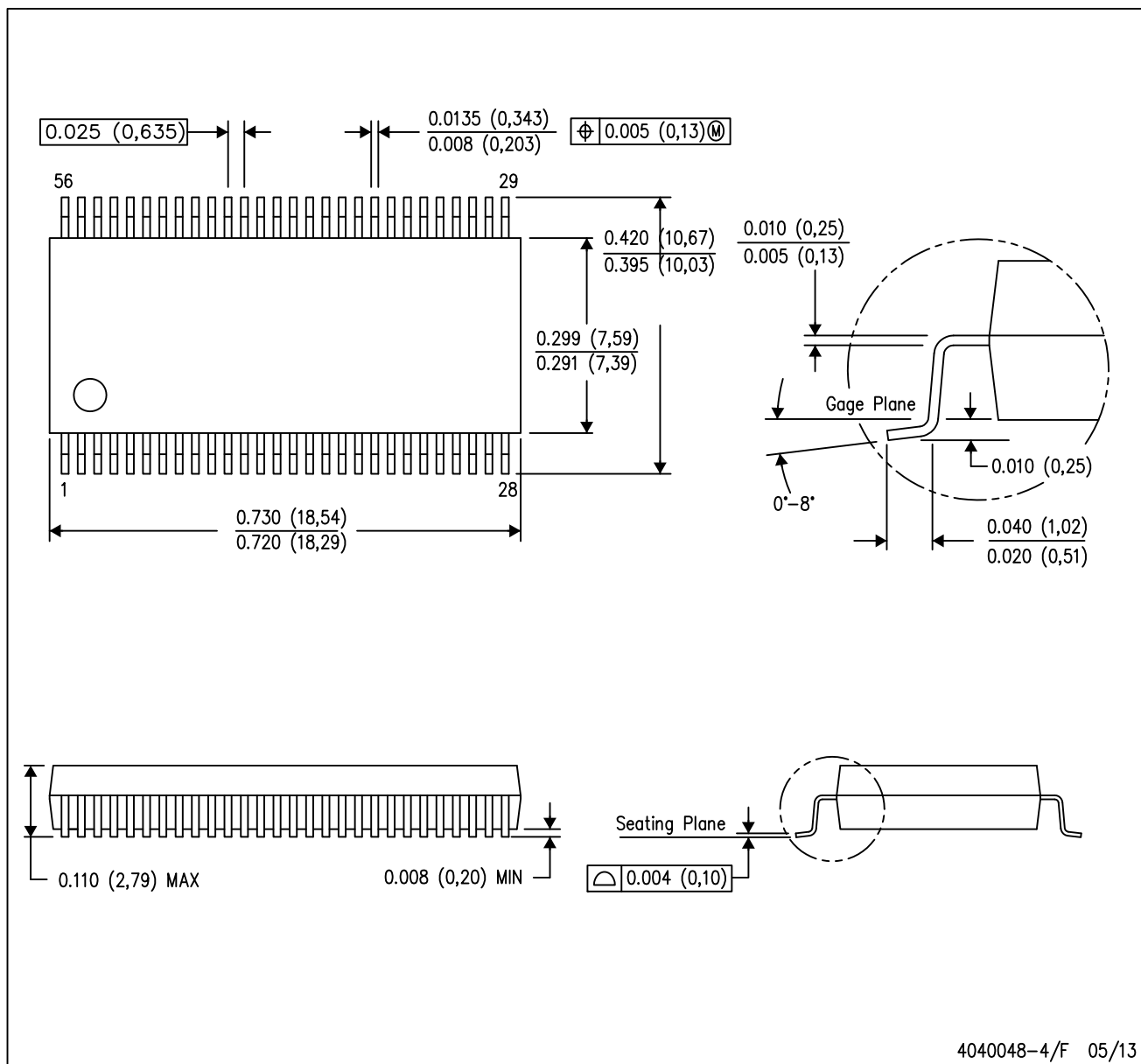
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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DL (R-PDSO-G56)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed  $0.006$  (0,15).
  - Falls within JEDEC MO-118

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